

1SB-302.2

AKA: *none*

Pick-up Points:

Obverse Markers

- Robust double features (see prior photos), with key feature being split W. This is the most robust of the 1SB obverse double die Family 3. The notching in at the end of the inner loop of the 9 is complete and the largest of the four 1SB-300 series DIVa Ikes from 1SB obverse double die Family 3. The split W displays the most spread in Family 3.
- Obverse clashes - upside down U (UDU), and “volunteer”
- Pupil detail largely retained - minimal die abrasion in front of pupil
- Die scratch starting at middle point of W in WE, running NW (common to both 302.1 and 302.2)
- Die scratch running transversely under the second T in TRUST (common to both 302.1 and 302.2)
- Die gouge dot and die scratch running between 9 and 7 (common to both 302.1 and 302.2)
- Fine die abrasion at top of head, under R to Y (common to both 302.1 and 302.2)
- MMP (common to both 302.1 and 302.2)

Reverse Markers

- Double die reverse - 1SB reverse double die family 3. Seen best in AR and notching in the left end of the olive branch.
- Die scratch near the base of the T in UNITED
- Partial die scratch between the LL - this one is high than that seen in the 302.1, and does not pass all the way between the LL













